

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Akihiko ENDO et al. Group Art Unit : 2812
Appl. No. : 10/569,942 Examiner : Sehvosh J NIKMANESH
Filed : February 28, 2006 Confirmation No. : 1077
For : METHOD FOR MANUFACTURING BONDED WAFER

SECOND SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop **AMENDMENT**
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir :

In accordance with the duty of disclosure under 37 C.F.R. § 1.56 and §§ 1.97-1.98, and further to the Information Disclosure Statements filed June 7, 2006 and February 8, 2008, Applicants submit herewith a Japanese Office Action dated February 18, 2009, conducted in Japanese Patent Application No. 2005-513521, which is a counterpart of the above-captioned application. This document details the relevance of the following documents, as determined by the Japanese Examiner:

- 1) Japanese Patent Publication No. JP 2000-030996, published on January 28, 2000.

Applicants note that this document was previously submitted and made of record by the Information Disclosure Statement submitted on June 7, 2006, and thus, no copy of this document is submitted herewith;

- 2) Japanese Patent Publication No. JP 07-249749, published on September 26, 1995.

Applicants note that this document was previously submitted and made of record by the

Information Disclosure Statement submitted on June 7, 2006, and thus, no copy of this document is submitted herewith; and

3) Japanese Patent Publication No. JP 11-186187, published on July 9, 1999. Applicants note that this document was previously submitted and made of record by the Information Disclosure Statement submitted on June 7, 2007, and thus, no copy of this document is submitted herewith.

Applicants respectfully submit that the foregoing documents have previously been cited by Applicant or the Examiner in the present application, and as such, such information is already of record and no certification is necessary.

No fee is believed necessary to ensure consideration of the submitted material. However, if for any reason a fee is deemed necessary, the Patent and Trademark Office is hereby authorized to charge Deposit Account No. 19-0089 any required fee to ensure consideration of the submitted materials.

If there should be any questions, the Examiner is invited to contact the undersigned at the telephone number listed below.

Respectfully Submitted,

Akihiko ENDO et al.



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